

2021 / 2022 Tower Semiconductor MPW Schedule

	Fab		Tape-In	Ship Date
SB*18 B4616	NPB - Fab 3	SiGe BiCMOS 0.18um	12/07/21	06/15/22
<i>Please contact your sales representative for information on fast track processing.</i>				
SB*18 B5001	NPB - Fab 3	SiGe BiCMOS 0.18um	02/08/22	08/16/22
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PH18MA B5002	NPB - Fab 3	SiPho 0.18um	02/22/22	07/08/22
CA18 B5003	NPB - Fab 3	RFCMOS 0.18um	03/15/22	08/24/22
<i>Please contact your sales representative for information on fast track processing.</i>				
SB*18 B5004	NPB - Fab 3	SiGe BiCMOS 0.18um	04/05/22	10/11/22
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SH222T18MAY	MH - Fab 2	CIS 0.18um Image Sensor	05/16/22	
		CMOS+ 0.16um, 0.18um RF, RFID, PM	05/23/22	
21st MPW Tonami, Japan	TPSCo - Fab 5	TS18	05/30/22	
		CMOS 0.18u & 0.16u, PM, PM_SOI		
PH18MA B5006	NPB - Fab 3	SiPho 0.18um	05/31/22	10/14/22
SB*18 B5007	NPB - Fab 3	SiGe BiCMOS 0.18um	06/14/22	12/20/22
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CS18* B5005	MH - Fab 2	CMOS-SOI 0.18um	06/28/22	
PH18MA B5008	NPB - Fab 3	SiPho 0.18um	07/19/22	12/02/22
SH322T18AUG	MH - Fab 2	CIS 0.18um Image Sensor	08/08/22	
		CMOS+ 0.16um, 0.18um RF, RFID, PM	08/15/22	

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SB*18 B5009	NPB - Fab 3	SiGe BiCMOS 0.18um	08/09/22	02/14/23
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CS18* B5010	MH - Fab 2	CMOS-SOI 0.18um	08/23/22	
22nd MPW Tonami, Japan	TPSCo - Fab 5	TS18 CMOS 0.18u & 0.16u, PM, PM_SOI	08/29/22	
SB*/CA/13* B5011	NPB - Fab 3	SiGe BiCMOS / RF CMOS 0.13um	08/30/22	04/26/23
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CA18 B5012	NPB - Fab 3	RFCMOS 0.18um	09/13/22	02/21/23
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22nd MPW Uozu, Japan	TPSCo - Fab 7	CMOS, PM & RFCMOS 65nm : TPS65SLA/SLC, TPS65PMA/PMB/MSA/MSB, TPS65RF	09/26/22	
SB*18 B5013	NPB - Fab 3	SiGe BiCMOS 0.18um	10/04/22	04/11/23
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23rd MPW Uozu, Japan	TPSCo - Fab 7	RFSOI 65nm:TPS90RSB2, TPS65RSA2/RSB	10/17/22	
PH18MA B5014	NPB - Fab 3	SiPho 0.18um	11/01/22	03/17/23
SH422T18NOV	MH - Fab 2	CIS 0.18um Image Sensor CMOS+ 0.16um, 0.18um RF, RFID, PM 0.18 BSI, Stacking on 0.13	11/14/22 11/21/22 11/14/22	
23rd MPW Tonami, Japan	TPSCo - Fab 5	TS18 CMOS 0.18u & 0.16u, PM, PM_SOI	11/28/22	

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SB*18	NPB - Fab 3	SiGe BiCMOS 0.18um	12/06/22	06/13/23
B5015	<i>Please contact your sales representative for information on fast track processing.</i>			

Notes :

"Shuttles" (SH\*) are run at Fab 2

\* 0.13u MH - fab 2 Shuttle / MPW slots will be considered per needs

Please contact your customer account manager for additional information.

Fab2 -- Tower Semiconductor 200mm wafer fabrication facility at Migdal Ha'emek, Israel

Fab3 -- Tower Semiconductor 200mm wafer fabrication facility at Newport Beach, CA

Fab5 -- Tower Semiconductor 200mm wafer fabrication facility at Tonami, Japan

Fab7 -- Tower Semiconductor 300mm wafer fabrication facility at Uozu, Japan